

**AMENDMENTS TO THE SPECIFICATION**

Paragraph [0001] of the electronically filed specification is amended to read as follows:

This application is a divisional application of U.S. Serial No. 10/604,009, filed June 20, 2003, now U.S. Patent 6,780,736, the contents of which are incorporated by reference herein in their entirety.

Paragraph [0014] of the electronically filed specification is amended to read as follows:

~~Figures 2(a)-2(d) illustrate~~ Figures 2(a)-2(e) illustrate examples of semiconductor devices with complementary implant regions having one or more alignment errors associated therewith; and